

HD74LV2GT00A

Dual 2-input NAND Gates / CMOS Logic Level Shifter

REJ03D0137-0200Z (Previous ADE-205-662A (Z)) Rev.2.00 Oct.14.2003

Description

The HD74LV2GT00A has dual two-input NAND gates in an 8 pin package. The input protection circuitry on this device allows over voltage tolerance on the input, allowing the device to be used as a logic–level translator from 3.0 V CMOS Logic to 5.0 V CMOS Logic or from 1.8 V CMOS logic to 3.0 V CMOS Logic while operating at the high-voltage power supply. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- TTL compatible input level.

Supply voltage range: 3.0 to 5.5 V

Operating temperature range: -40 to +85°C

• Logic-level translate function

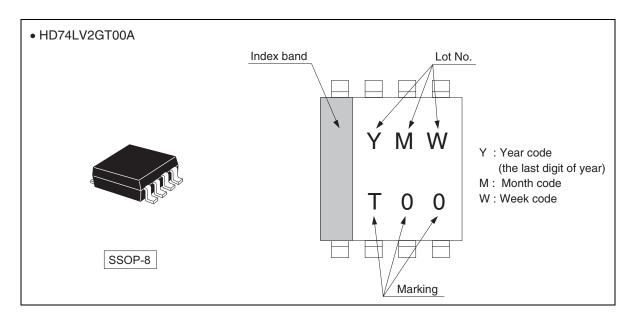
 $3.0 \text{ V CMOS logic} \rightarrow 5.0 \text{ V CMOS logic} (@V_{CC} = 5.0 \text{ V})$

1.8 V or 2.5 V CMOS logic \rightarrow 3.3 V CMOS logic (@V_{CC} = 3.3 V)

- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

| Part Name | Package Type | Package Code | Package Abbreviation | Taping Abbreviation (Quantity) |
|-----------------|--------------|--------------|-------------------------|--------------------------------|
| HD74LV2GT00AUSE | SSOP-8 pin | TTP-8DBV | US | E (3,000 pcs/reel) |

Outline and Article Indication



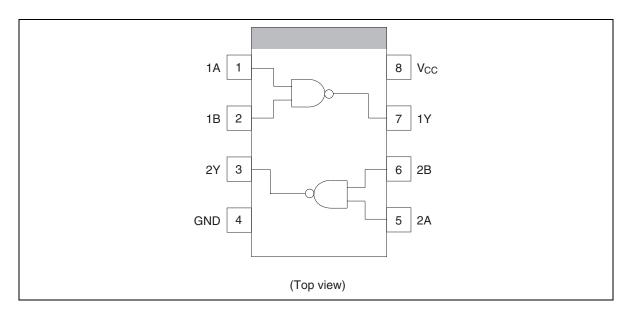
Function Table

Inputs

| A | В | Output Y |
|---|---|----------|
| L | L | Н |
| L | Н | Н |
| Н | L | Н |
| Н | Н | L |

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

| Item | Symbol | Ratings | Unit | Test Conditions |
|--|-------------------------------------|--------------------------|------|-----------------------------|
| Supply voltage range | Vcc | –0.5 to 7.0 | V | |
| Input voltage range *1 | Vı | -0.5 to 7.0 | V | |
| Output voltage range *1, 2 | Vo | -0.5 to V_{CC} + 0.5 | V | Output : H or L |
| | | -0.5 to 7.0 | | V _{CC} : OFF |
| Input clamp current | I _{IK} | -20 | mA | V _I < 0 |
| Output clamp current | I _{OK} | ±50 | mA | $V_O < 0$ or $V_O > V_{CC}$ |
| Continuous output current | Io | ±25 | mA | $V_O = 0$ to V_{CC} |
| Continuous current through V _{CC} or GND | I _{CC} or I _{GND} | ±50 | mA | |
| Maximum power dissipation at Ta = 25°C (in still air) *3 | P _T | 200 | mW | |
| Storage temperature | Tstg | -65 to 150 | °C | |

Notes:

The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

HD74LV2GT00A

Recommended Operating Conditions

| Item | Symbol | Ratings | Unit |
|------------------------|---------------------------------|---|-------------|
| Supply voltage | V _{CC} | 3.0 to 5.5 | V |
| Input voltage | V _{IN} | 0 to 5.5 | V |
| Output voltage | V _{OUT} | 0 to V _{CC} | V |
| Operating temperature | T _{opr} | -40 to +85 | °C |
| Input rise / fall time | t _r , t _f | 0 to 100 (V _{CC} = 3.0 to 3.6 V) | ns |
| | | 0 to 20 (V _{CC} = 4.5 to 5.5 V) | |

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}C$

| Item | Symbol | V _{CC} (V) * | Min | Тур | Max | Unit | Test condition |
|--------------------------|------------------|-----------------------|----------------------|------|------|--------------|--|
| Input voltage | V _{IH} | 3.0 to 3.6 | 1.5 | _ | _ | V | |
| | | 4.5 to 5.5 | 2.0 | _ | _ | _ | |
| | V _{IL} | 3.0 to 3.6 | _ | _ | 0.6 | | |
| | | 4.5 to 5.5 | _ | _ | 8.0 | _ | |
| Hysteresis voltage | V _H | 3.3 | _ | 0.10 | _ | V | $V_T^+ - V_T^-$ |
| | | 5.0 | | 0.15 | _ | | |
| Output voltage | V _{OH} | Min to Max | V _{CC} -0.1 | _ | _ | V | $I_{OH} = -50 \ \mu A$ |
| | | 3.0 | 2.48 | _ | _ | _ | $I_{OH} = -6 \text{ mA}$ |
| | | 4.5 | 3.8 | _ | _ | | $I_{OH} = -12 \text{ mA}$ |
| | V _{OL} | Min to Max | _ | _ | 0.1 | _ | $I_{OL} = 50 \mu A$ |
| | | 3.0 | _ | _ | 0.44 | _ | I _{OL} = 6 mA |
| | | 4.5 | _ | _ | 0.55 | | I _{OL} = 12 mA |
| Input current | I _{IN} | 0 to 5.5 | _ | _ | ±1 | μΑ | V _{IN} = 5.5 V or GND |
| Quiescent supply current | I _{CC} | 5.5 | _ | _ | 10 | μΑ | $V_{IN} = V_{CC}$ or GND, $I_O = 0$ |
| | ΔI_{CC} | 5.5 | _ | _ | 1.5 | mA | One input $V_{IN} = 3.4 \text{ V}$, other input V_{CC} or GND |
| Output leakage current | I _{OFF} | 0 | | _ | 5 | μΑ | V _O = 5.5 V |
| Input capacitance | C _{IN} | 5.0 | _ | 2.5 | _ | pF | $V_{IN} = V_{CC}$ or GND |

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $\bullet \quad V_{CC} = 3.3 \pm 0.3 \ V$

| | | Ta = 2 | 25°C | | Ta = - | 40 to 85°C | | Test | FROM | TO |
|-------------|------------------|--------|------|------|--------|------------|------|------------------------|---------|----------|
| Item | Symbol | Min | Тур | Max | Min | Max | Unit | Conditions | (Input) | (Output) |
| Propagation | t _{PLH} | _ | 7.0 | 10.0 | 1.0 | 12.0 | ns | C _L = 15 pF | A or B | Υ |
| delay time | t _{PHL} | _ | 7.5 | 12.0 | 1.0 | 14.0 | _ | C _L = 50 pF | _ | |

• $V_{CC} = 5.0 \pm 0.5 \text{ V}$

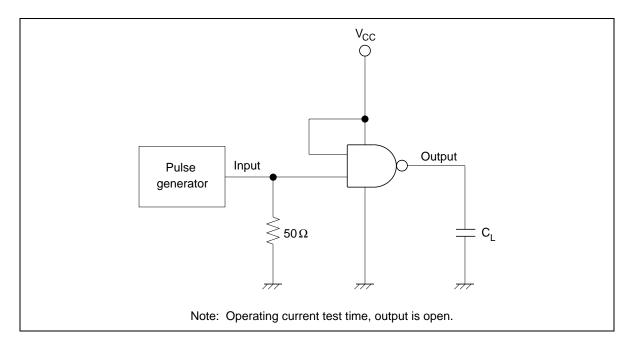
| | | Ta = 2 | 25°C | | Ta = -4 | 40 to 85°C | | Test | FROM | TO |
|-------------|------------------|--------|------|-----|---------|------------|------|------------------------|---------|----------|
| Item | Symbol | Min | Тур | Max | Min | Max | Unit | Conditions | (Input) | (Output) |
| Propagation | t _{PLH} | _ | 5.0 | 6.9 | 1.0 | 8.0 | ns | C _L = 15 pF | A or B | Υ |
| delay time | t _{PHL} | _ | 5.5 | 7.9 | 1.0 | 9.0 | | $C_L = 50 pF$ | | |

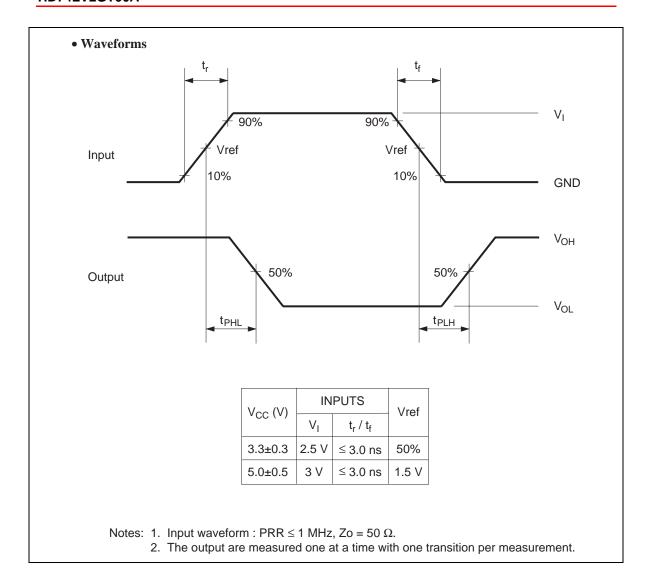
Operating Characteristics

• $C_L = 50 pF$

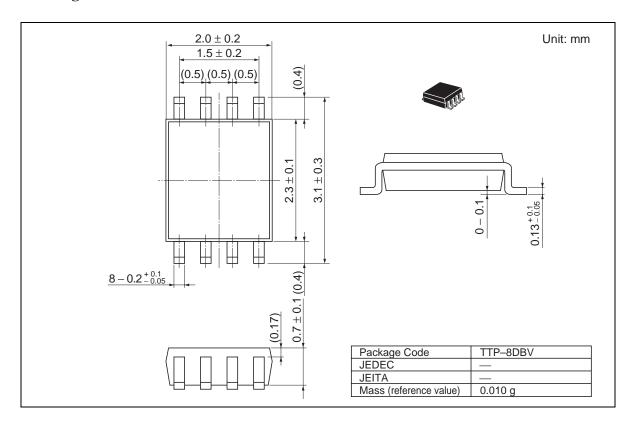
| | | | Ta = 2 | 5°C | | | |
|-------------------------------|----------|---------------------|--------|------|-----|------|------------------------|
| Item | Symbol | V _{CC} (V) | Min | Тур | Max | Unit | Test Conditions |
| Power dissipation capacitance | C_{PD} | 5.0 | _ | 11.0 | _ | pF | f = 10 MHz |

Test Circuit





Package Dimensions



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